



## TO-220F Plastic-Encapsulate MOSFETS

### PF12N65

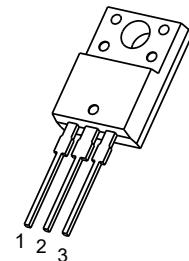
N-Channel Power MOSFET

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> TYP	I <sub>D</sub>
650V	0.7Ω@10V	12A

#### GENERAL DESCRIPTION

This advanced high voltage MOSFET is designed to stand high energy in the avalanche mode and switch efficiently. This new high energy device also offers a drain-to-source diode fast recovery time. Designed for high voltage, high speed switching applications such as power supplies, converters, power motor controls and bridge circuits.

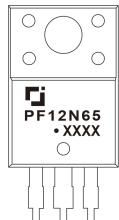
#### TO-220F



#### FEATURE

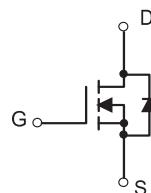
- High Current Rating
- Lower R<sub>DS(on)</sub>
- Lower Capacitance
- Lower Total Gate Charge
- Tighter V<sub>SD</sub> Specifications
- Avalanche Energy Specified
- Fast Switching Capability

#### MARKING



PF12N65= Device code Solid dot = Green molding compound device, if none, the normal device  
XXXX=Code

#### EQUIVALENT CIRCUIT



#### Maximum ratings (T<sub>a</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	650	V
Gate-Source Voltage	V <sub>GS</sub>	±30	V
Continuous Drain Current	I <sub>D</sub> <sup>①</sup>	12	A
Pulsed Drain Current	I <sub>DM</sub> <sup>②</sup>	48	A
Single Pulsed Avalanche Energy	E <sub>AS</sub> <sup>③</sup>	540	mJ
Power Dissipation	P <sub>D</sub> <sup>①</sup>	50	W
Thermal Resistance from Junction to Ambient	R <sub>θJA</sub> <sup>⑥</sup>	62.5	°C/W
Thermal Resistance from Junction to Case	R <sub>θJC</sub> <sup>①</sup>	2.5	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 ~+150	°C

## MOSFET ELECTRICAL CHARACTERISTICS

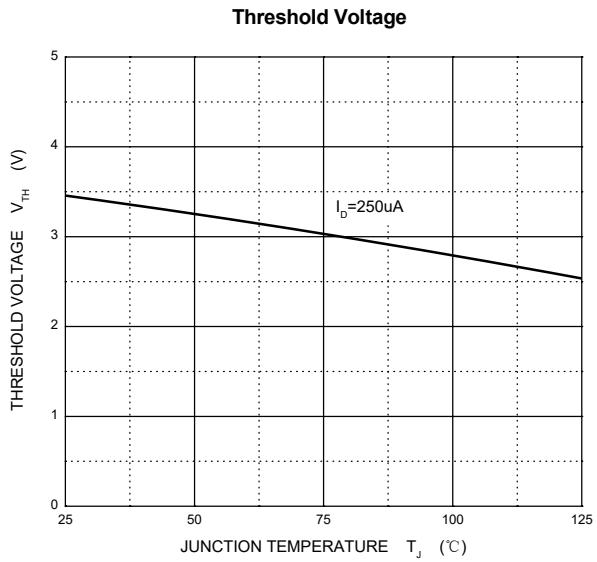
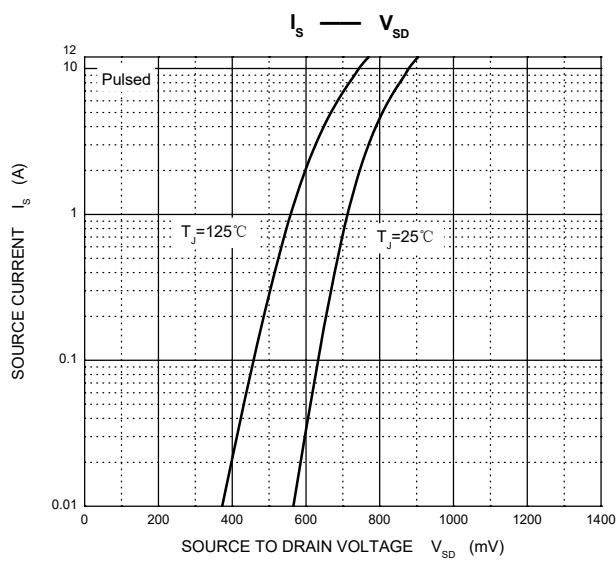
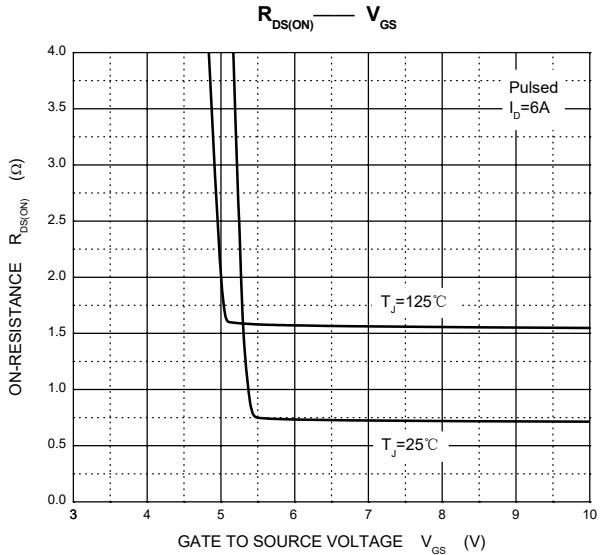
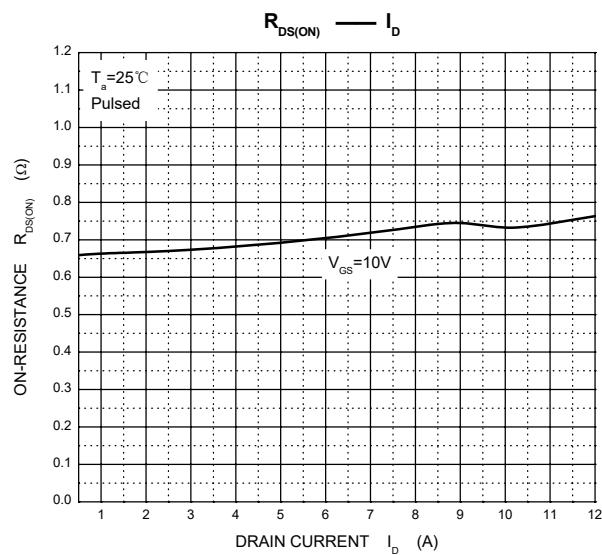
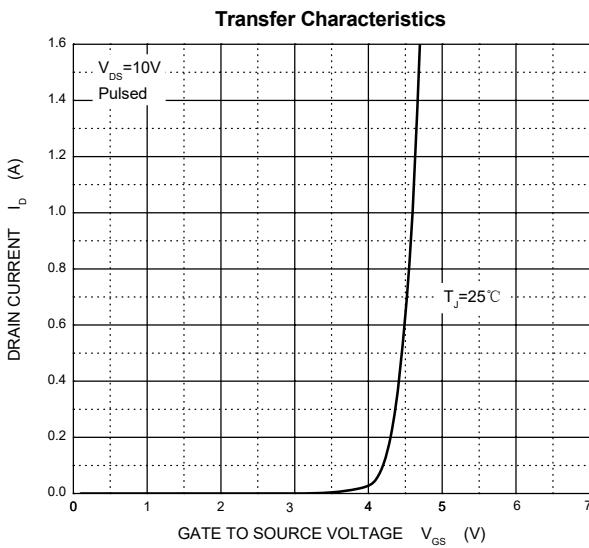
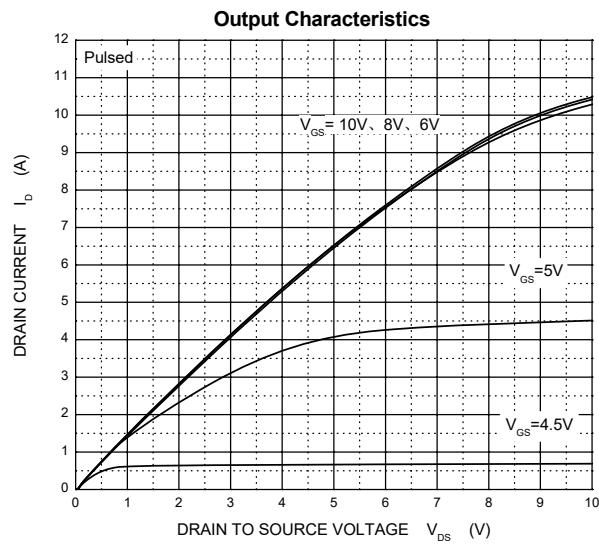
$T_a=25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Off characteristics</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	650			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 650V, V_{GS} = 0V$			10	$\mu\text{A}$
Gate-body leakage current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 30V$			$\pm 100$	nA
<b>On characteristics<sup>④</sup></b>						
Gate-threshold voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2	3.5	4	V
Static drain-source on-resistance	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 6A$		0.7	0.85	$\Omega$
<b>Dynamic characteristics<sup>④⑤</sup></b>						
Input capacitance	$C_{iss}$	$V_{DS} = 25V, V_{GS} = 0V, f = 1\text{MHz}$		1800		pF
Output capacitance	$C_{oss}$			200		
Reverse transfer capacitance	$C_{rss}$			25		
<b>Switching characteristics<sup>④⑤</sup></b>						
Total gate charge	$Q_g$	$V_{DS} = 520V, V_{GS} = 10V, I_D = 12A$		42	54	nC
Gate-source charge	$Q_{gs}$			8.6		
Gate-drain charge	$Q_{gd}$			21		
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 325V, V_{GS} = 10V, R_G = 25\Omega, I_D = 12A$		30		ns
Turn-on rise time	$t_r$			90		
Turn-off delay time	$t_{d(off)}$			160		
Turn-off fall time	$t_f$			90		
<b>Drain-Source Diode Characteristics</b>						
Drain-source diode forward voltage	$V_{SD}^{④}$	$V_{GS} = 0V, I_S = 12A$			1.4	V
Maximum continuous drain-source diode forward current	$I_S^{①}$				12	A
Maximum pulsed drain-source diode forward current	$I_{SM}^{②}$				48	A

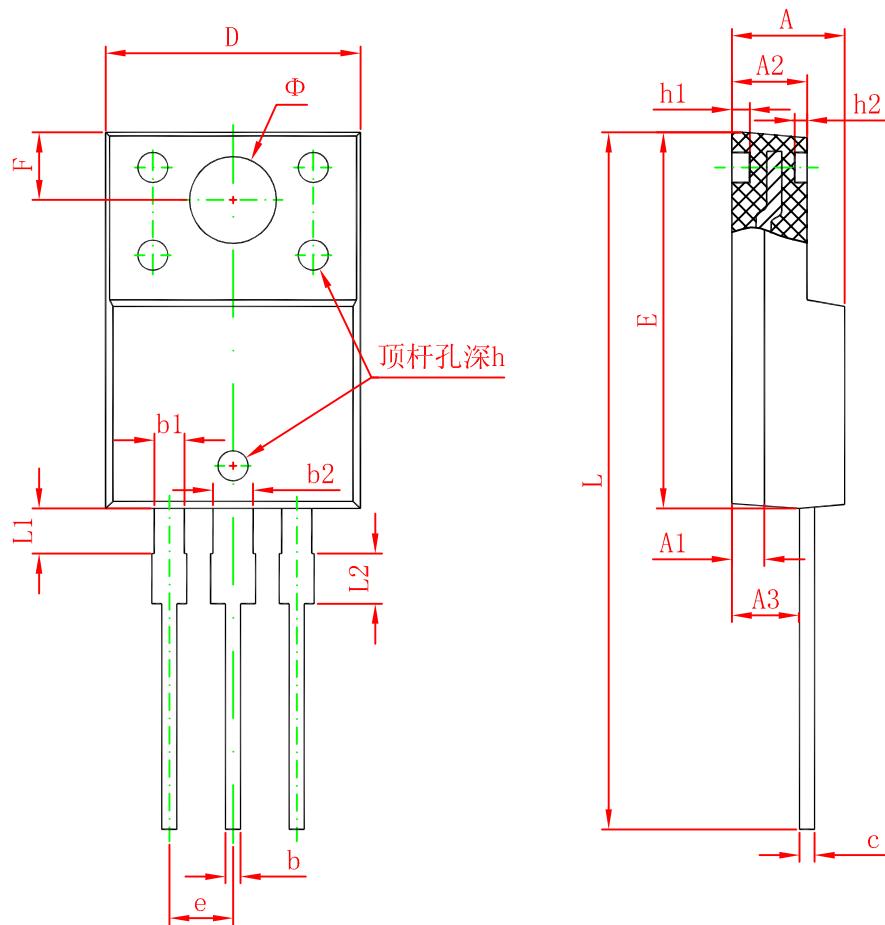
### Notes :

1.  $T_c=25^\circ\text{C}$  Limited only by maximum temperature allowed.
2.  $P_w \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$ .
3. EAS condition:  $V_{DD}=50V, V_{GS}=10V, L=7.5\text{mH}, R_g=25\Omega$  Starting  $T_J = 25^\circ\text{C}$ .
4. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
5. Guaranteed by design, not subject to production.
6. The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25^\circ\text{C}$ .

## Typical Characteristics



## TO-220F Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300	REF.	0.051	REF.
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.100	1.350	0.043	0.053
b2	1.500	1.750	0.059	0.069
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540 TYP.		0.100 TYP.	
F	2.700 REF.		0.106 REF.	
Φ	3.500 REF.		0.138 REF.	
h	0.000	0.300	0.000	0.012
h1	0.800 REF.		0.031 REF.	
h2	0.500 REF.		0.020 REF.	
L	28.000	28.400	1.102	1.118
L1	1.700	1.900	0.067	0.075
L2	0.900	1.100	0.075	0.083